nexperia

Quarterly Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021

Based on structural similarity

Supplier Nexperia B.V. Name of Laboratory		User Part Number						
		PCMF2HDMI2S						
		Part Description						
		NXP ICN8	Protection INE	DI				
Assembly reliability labs		WLCSP package						
Test		Test Conditions	Duration	# Lots	# Quantity	# Rejects		
	TEST							
	Pre- and Post-Stress							
# 1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below		
		MIL-STD-750-1						
	HTRB	M1038 Method A						
	High Temperature Reverse	Tj = Tjmax, Vr = 100% of max. datasheet						
# 5	Bias	reverse voltage	1000 hours	43	3440	0		
	тс	JESD22-A104						
# 7	Temperature Cycling	-40 °C to 125°C	1000 cycles	16	1280	0		
		JESD22-A102						
	AC	Tamb = 121 °C, RH = 100 %						
# 8	Autoclave	Pressure = 205 kPa (29.7 psia)	96 hours	n.a.	n.a.	n.a.		
			50 110010					
	HAST	JESD22-A110						
	Highly Accelerated Stress	Tamb = 130 °C, RH = 85%, VR = 80 % of						
# 9	Test	rated reverse voltage ^[1]	1000 hours	16	1280	0		
# 9		MIL-STD-750 Method 1037	1000 110013	10	1200	0		
	IOL	mil-SID-750 Method 1037 ton = toff, devices powered to insure ΔT_i =						
# 10	IOL Intermittent Operating Life		1000 hours					
# 10	Internittent Operating Life	100 C 101 15000 Cycles	1000 Hours	n.a.	n.a.	n.a.		
	RSH	JESD22-A111						
# 20	Resistance to Solder Heat		10 -					
# 20		200 C ± 5 C	10 s	n.a.	n.a.	n.a.		
	SD Caldershility	1 CTD 003						
# 21	Solderability	J-STD-002		n.a.	n.a.	n.a.		

[1] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test # 5)

Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

NXP ICN8 Protection INDI 3440 0 1.2 8.10E+08	Wafer Fab	Technology	Quantity	Rejects	Failure Rate (FIT)	MTTF (hrs)
	NXP ICN8	Protection INDI	3440	0	1.2	8.10E+08

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